Electronic Patent Application Fee Transmittal									
Application Number:	10706977								
Filing Date:	14-Nov-2003								
Title of Invention:	Wafer processing apparatus having dust proof function								
First Named Inventor/Applicant Name:	Tsutomu Okabe								
Filer:	Marvin Jay Spivak/lan Hall-Hough								
Attorney Docket Number:	245166US3CIP								
Filed as Large Entity									
Utility Filing Fees									
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)				
Basic Filing:									
Pages:									
Claims:									
Miscellaneous-Filing:									
Petition:									
Patent-Appeals-and-Interference:									
Post-Allowance-and-Post-Issuance:									
Extension-of-Time:									
Extension - 2 months with \$120 paid		1252	1	340	340				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)	
Miscellaneous:					
Request for continued examination	1801	1	810	810	
	Tota	Total in USD (\$)			